

#21A  
11-15-01  
566.39787CX1 400

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): T. UCHIDA, et al.

Serial No.: Not Yet Assigned  
(Continuation Application of SN 09/763,891  
Filed: February 28, 2001)

Filed: October 15, 2001

For: ABRASIVE LIQUID FOR METAL AND METHOD  
OF POLISHING

**PRELIMINARY AMENDMENT**

Assistant Commissioner of Patents  
Washington, D.C. 20231

October 15, 2001

Sir:

Please amend the above-identified application, prior to examination  
thereof, as follows:

**IN THE SPECIFICATION:**

Page 1, between the title and the heading "Technical Field", please add the  
following new paragraph:

A/ This application is a Continuation application of application Serial No.  
09/763,891, filed <sup>June 11,</sup> ~~February 28~~, 2001, which is a National Stage application filed  
under 35 USC §371 of International (PCT) Application No. PCT/JP99/04694,  
filed August 31, 1999.